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## Features

### Inputs/Outputs

- Accepts differential or single-ended input
  - LVPECL, LVDS, CML, HCSL, LVCMOS
- On-chip input termination resistors and biasing for AC coupled inputs
- Eight precision LVPECL outputs
- Operating frequency up to 750 MHz

### Power

- Options for 2.5 V or 3.3 V power supply
- Core current consumption of 122 mA
- On-chip Low Drop Out (LDO) Regulator for superior power supply rejection

### Performance

- Ultra low additive jitter of 36 fs RMS

### Ordering Information

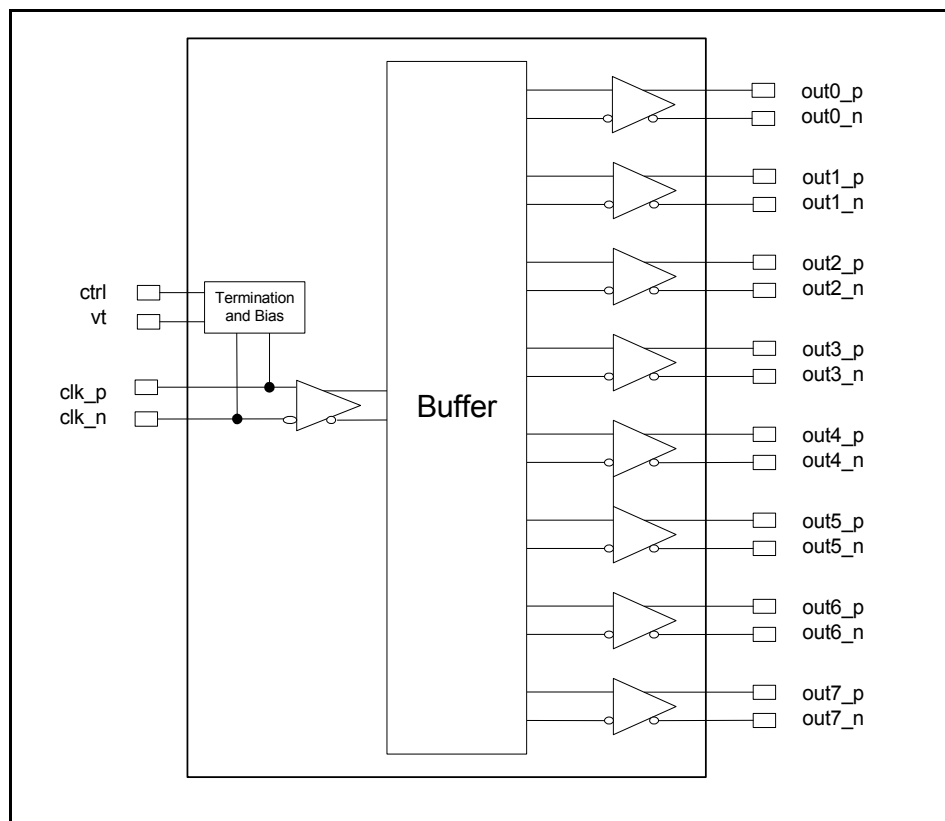
ZL40207LDG1	32 Pin QFN	Trays
ZL40207LDF1	32 Pin QFN	Tape and Reel
Matte Tin		

Package size: 5 x 5 mm

**-40°C to +85°C**

## Applications

- General purpose clock distribution
- Low jitter clock trees
- Logic translation
- Clock and data signal restoration
- Wired communications: OTN, SONET/SDH, GE, 10 GE, FC and 10G FC
- Wireless communications
- High performance microprocessor clock distribution



**Figure 1 - Functional Block Diagram**

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## Change Summary

Below are the changes from the November 2012 issue to the February 2013 issue:

Page	Item	Change
7	Figure 4	Changed text to indicate the circuit is not recommended for VDD_driver=2.5V.

### 1.0 Package Description

The device is packaged in a 32 pin QFN

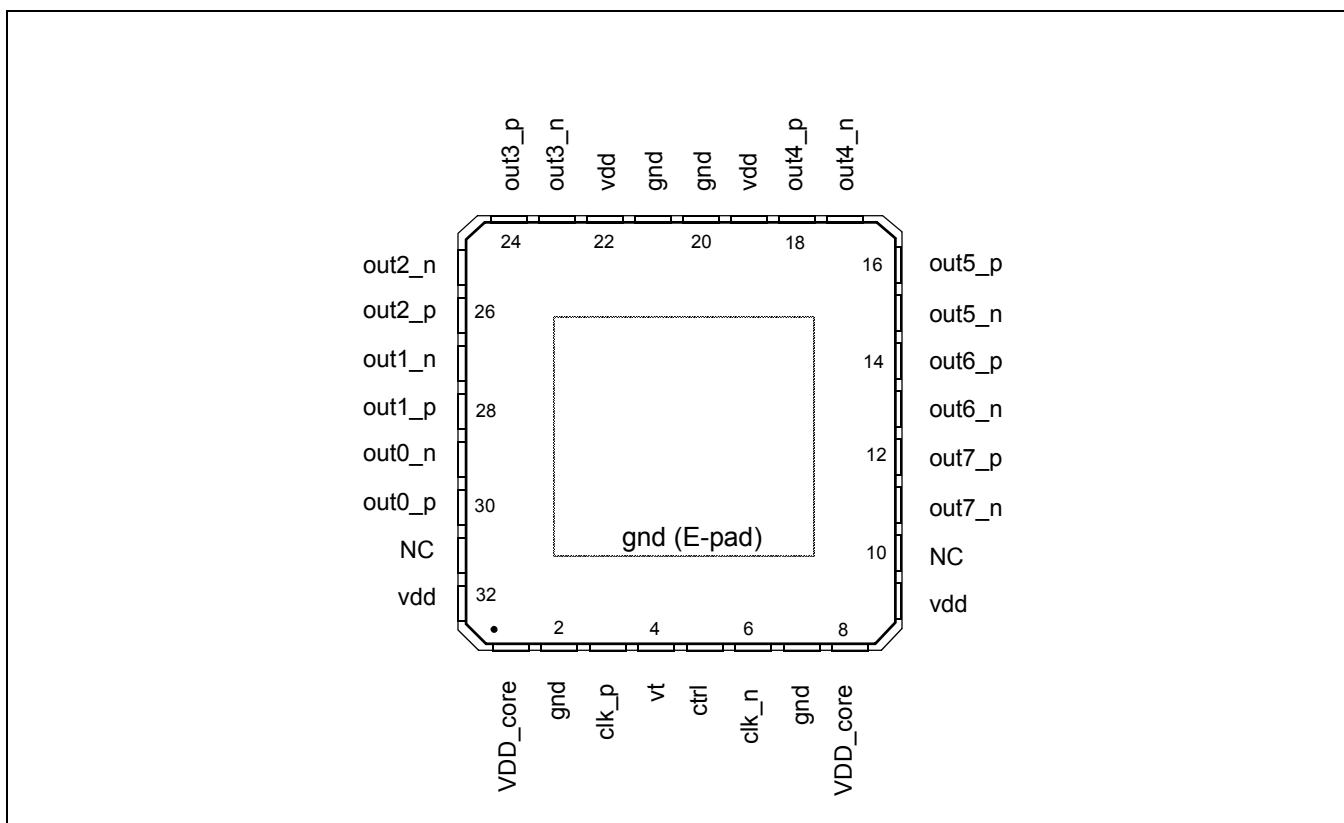


Figure 2 - Pin Connections

## 2.0 Pin Description

Pin #	Name	Description
3, 6	clk_p, clk_n,	<b>Differential Input (Analog Input).</b> Differential (or single ended) input signals. For all input configurations see "Clock Inputs" on page 6
30, 29, 28, 27, 26, 25, 24, 23, 18, 17, 16, 15, 14, 13, 12, 11	out0_p, out0_n out1_p, out1_n out2_p, out2_n out3_p, out3_n out4_p, out4_n out5_p, out5_n out6_p, out6_n out7_p, out7_n	<b>Differential Output (Analog Output).</b> Differential outputs.
9, 19, 22, 32	vdd	<b>Positive Supply Voltage.</b> 2.5 V <sub>DC</sub> or 3.3 V <sub>DC</sub> nominal.
1, 8	vdd_core	<b>Positive Supply Voltage.</b> 2.5 V <sub>DC</sub> or 3.3 V <sub>DC</sub> nominal.
2, 7, 20, 21	gnd	<b>Ground.</b> 0 V.
4	vt	<b>On-Chip Input Termination Node (Analog).</b> Center tap between internal 50 Ohm termination resistors. The use of this pin is detailed in section 3.1, "Clock Inputs", for various input signal types.
5	ctrl	<b>Digital Control for On-Chip Input Termination (Input).</b> Selects differential input mode; 0: DC coupled LVPECL or LVDS modes 1: AC coupled differential modes This pin are internally pulled down to GND. The use of this pin is detailed in section 3.1, "Clock Inputs", for various input signal types.
10, 31	NC	<b>No Connection.</b> Leave unconnected.

### 3.0 Functional Description

The ZL40207 is an LVPECL clock fan out buffer with eight output clock drivers capable of operating at frequencies up to 750MHz.

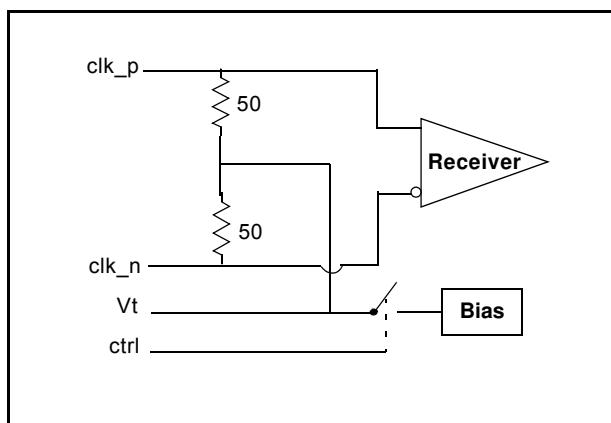
The ZL40207 provides an internal input termination network for DC and AC coupled inputs; optional input biasing for AC coupled inputs is also provided. The ZL40207 can accept DC or AC coupled LVPECL and LVDS input signals, AC coupled CML or HCSL input signals, and single ended signals. A pin compatible device with external termination is also available.

The ZL40207 is designed to fan out low-jitter reference clocks for wired or optical communications applications while adding minimal jitter to the clock signal. An internal linear power supply regulator and bulk capacitors minimize additive jitter due to power supply noise. The device operates from 2.5V $\pm$ 5% or 3.3V $\pm$ 5% supply. Its operation is guaranteed over the industrial temperature range -40°C to +85°C.

The device block diagram is shown in Figure 1; its operation is described in the following sections.

#### 3.1 Clock Inputs

The device has a differential input equipped with two on-chip 50 Ohm termination resistors arranged in series with a center tap. The input can accept many differential and single-ended signals with AC or DC coupling as appropriate. A control pin is available to enable internal biasing for AC coupled inputs. A block diagram of the input stage is in Figure 3.

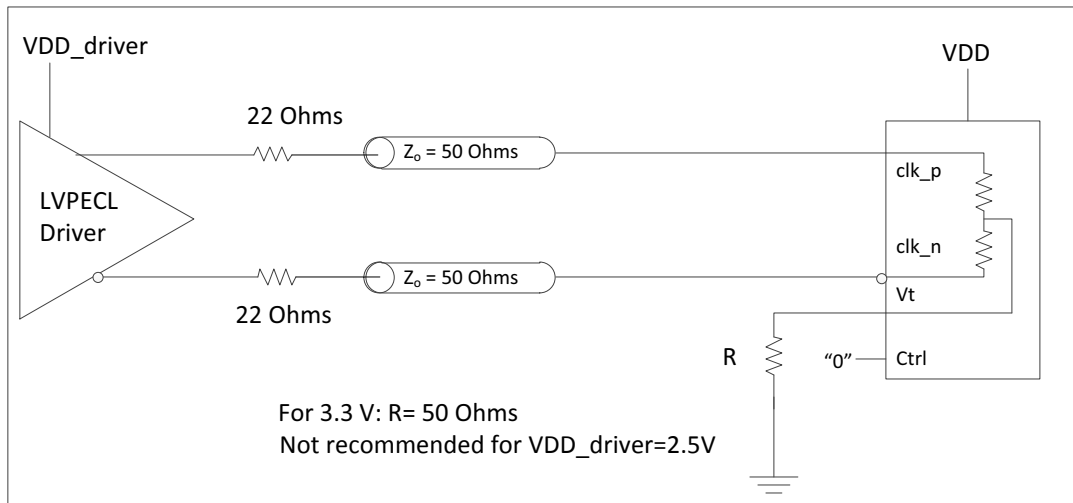


**Figure 3 - Simplified Diagram of Input Stage**

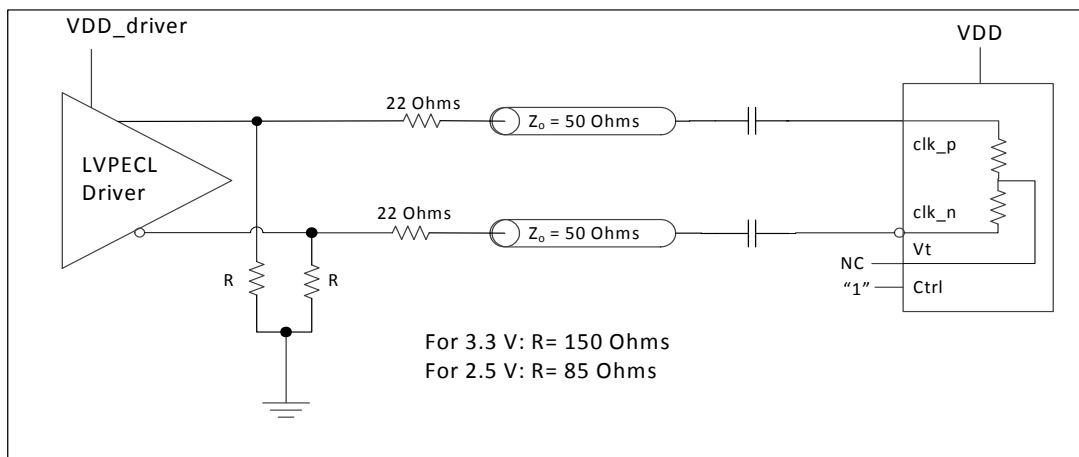
The following figures give the components values and configuration for the various circuits compatible with the input stage and the use of the *Vt* and *ctrl* pins in each case.

In the following diagrams where the *ctrl* pin is logically one and the *Vt* pin is not connected, the *Vt* pin can be instead connected to VDD with a capacitor. A capacitor can also help in Figure 4 between *Vt* and VDD. This capacitor will minimize the noise at the point between the two internal termination resistors and improve the overall performance of the device.

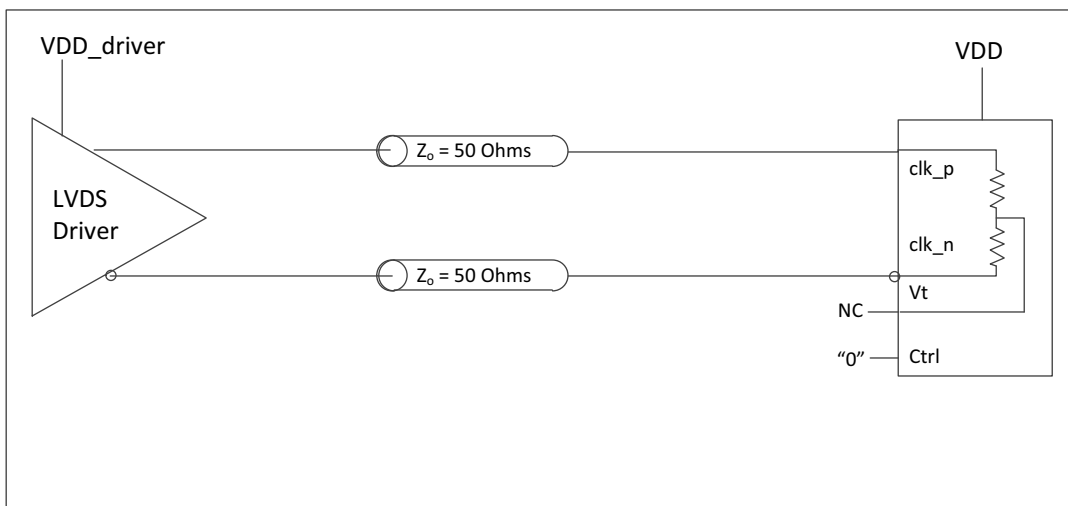




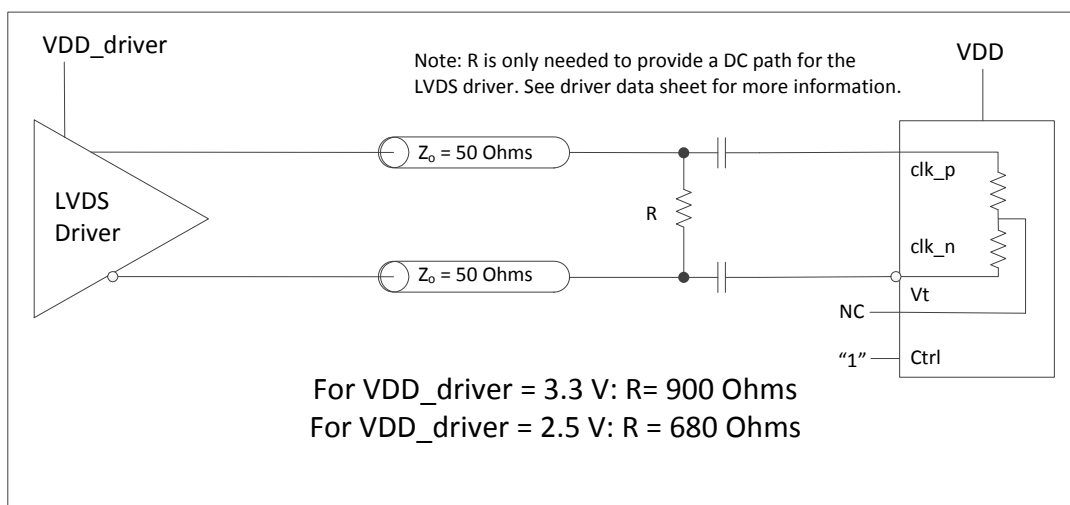
**Figure 4 - Clock Input - LVPECL - DC Coupled**



**Figure 5 - Clock Input - LVPECL - AC Coupled**



**Figure 6 - Clock Input - LVDS - DC Coupled**



**Figure 7 - Clock Input - LVDS - AC Coupled**

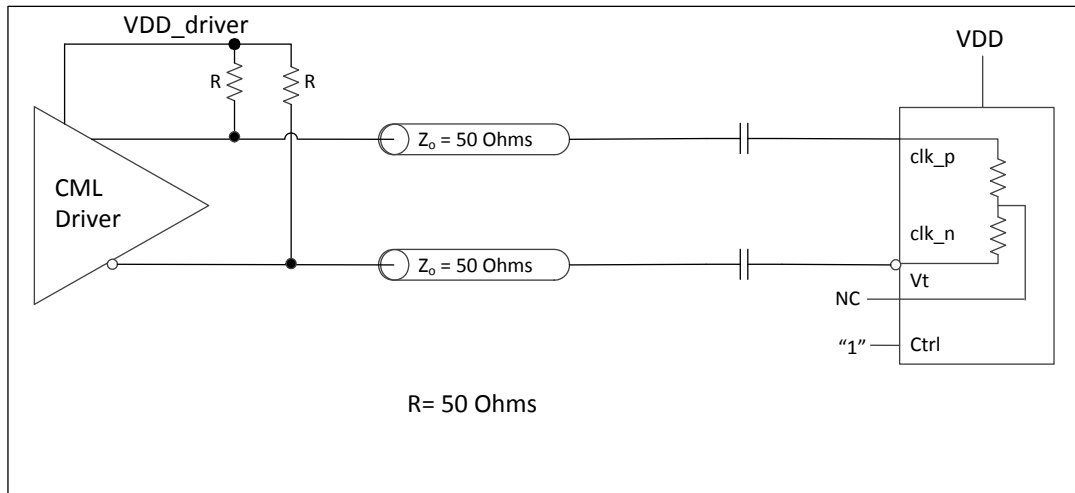


Figure 8 - Clock Input - CML- AC Coupled

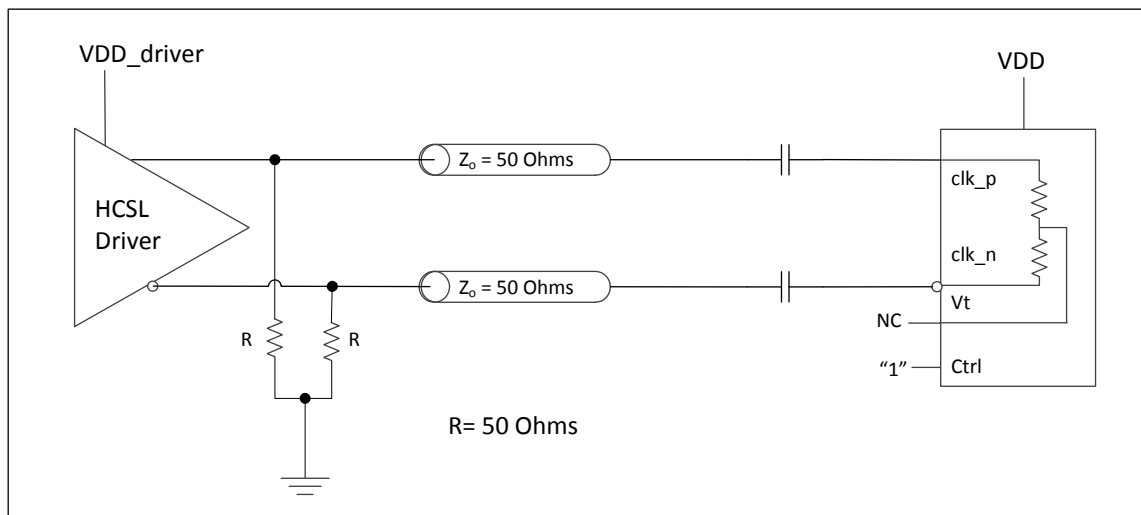


Figure 9 - Clock Input - HCSL- AC Coupled

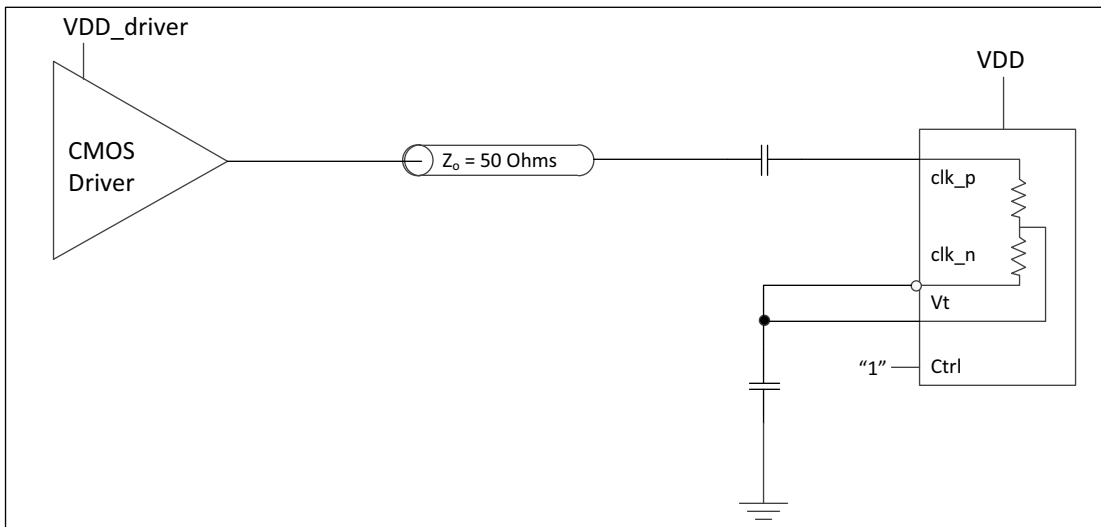


Figure 10 - Clock Input - AC-coupled Single-Ended

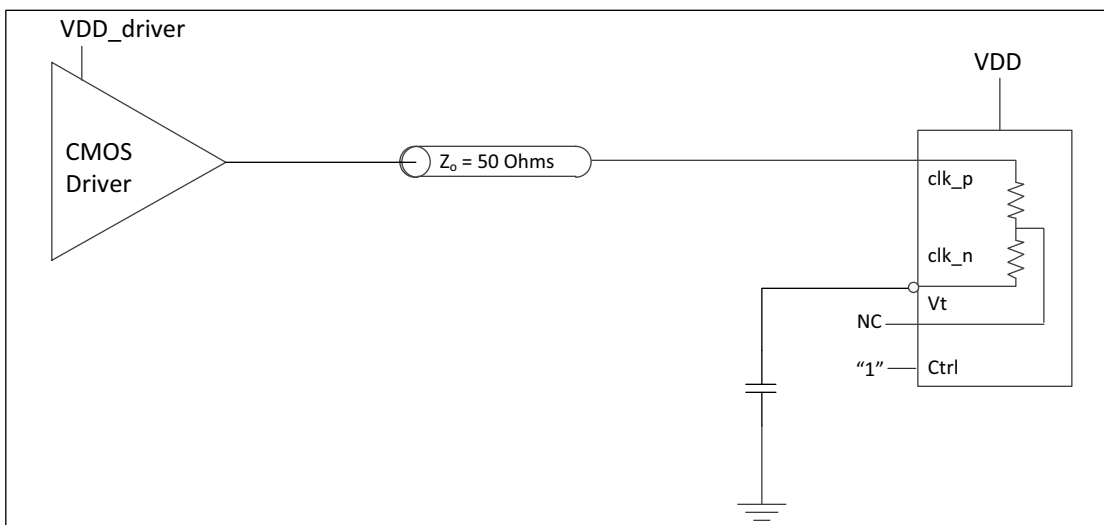
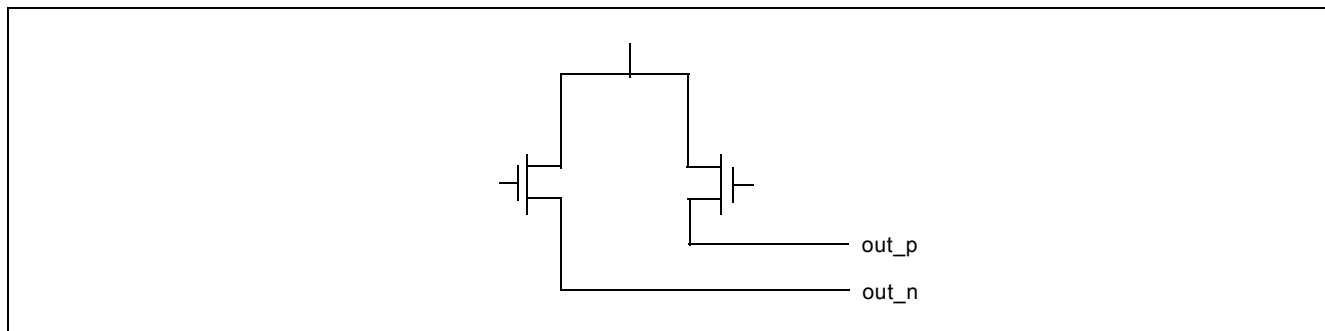


Figure 11 - Clock Input - DC-coupled 3.3V CMOS

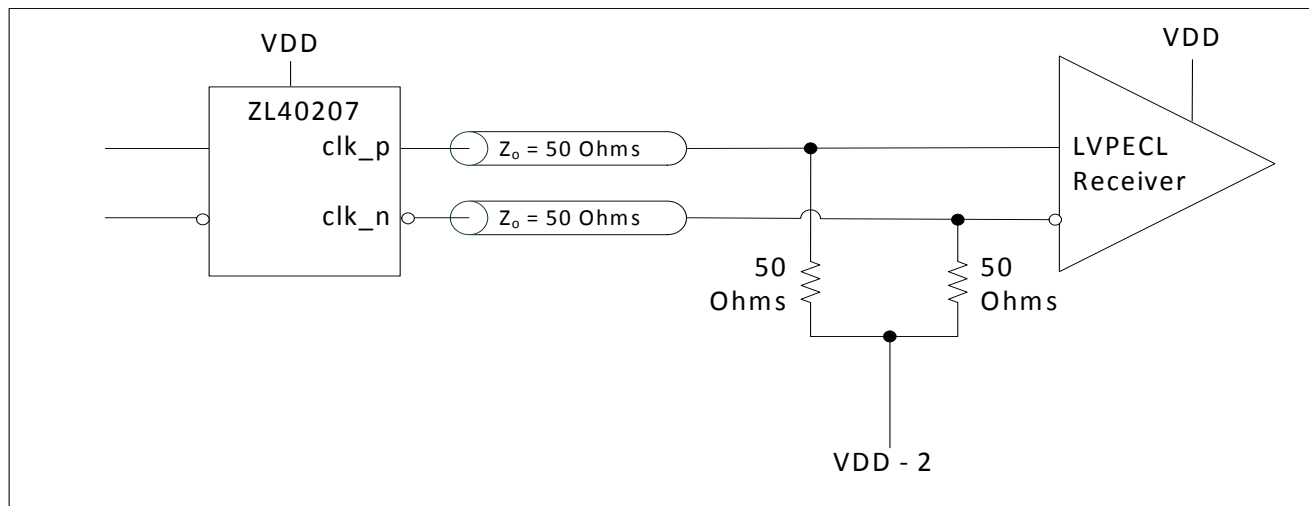
### 3.2 Clock Outputs

LVPECL has a very low output impedance and a differential signal swing between 1V and 1.6 V. A simplified diagram for the output stage is shown in Figure 12. The LVPECL to LVDS output termination is not shown since there is a different device with the same inputs and LVDS outputs.

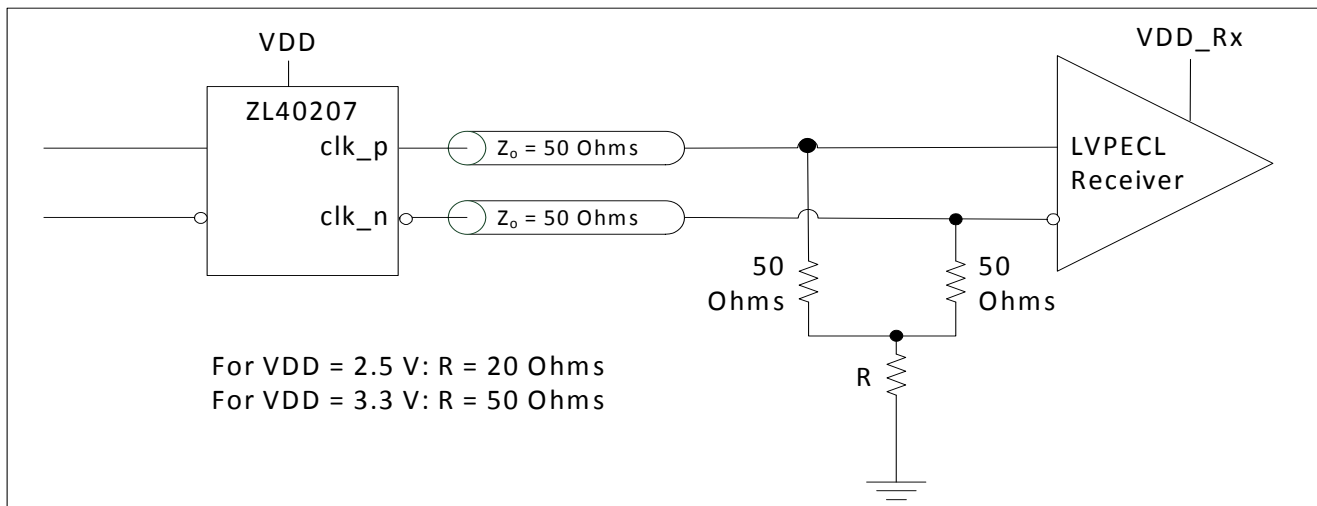


**Figure 12 - Simplified Output Driver**

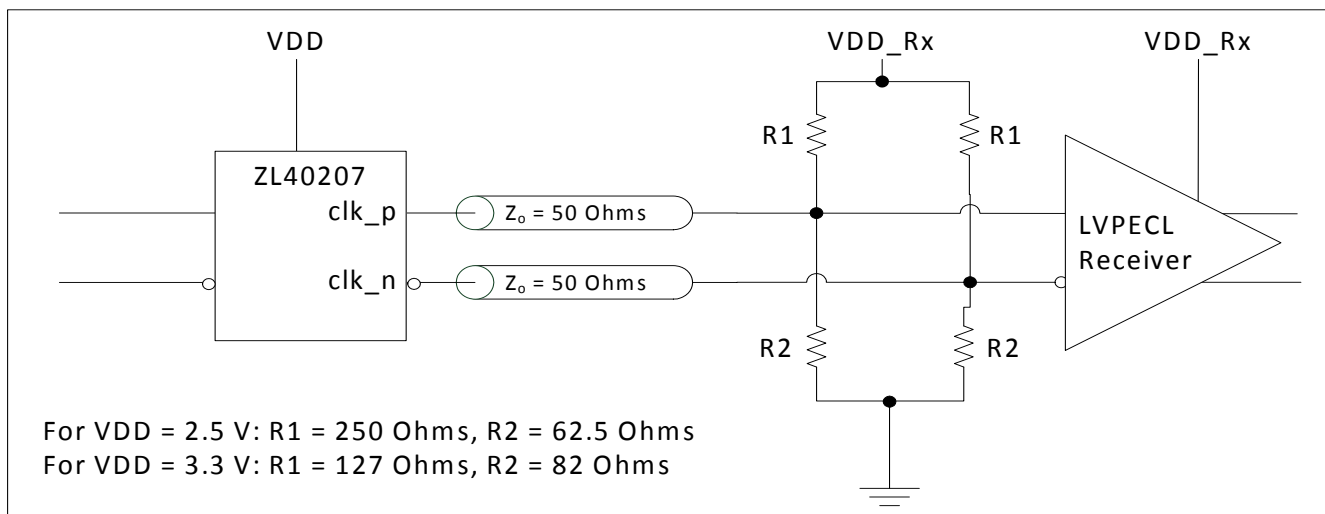
The methods to terminate the ZL40207 LVPECL drivers are shown in the following figures.



**Figure 13 - LVPECL Basic Output Termination**



**Figure 14 - LVPECL Parallel Output Termination**



**Figure 15 - LVPECL Parallel Thevenin-Equivalent Output Termination**

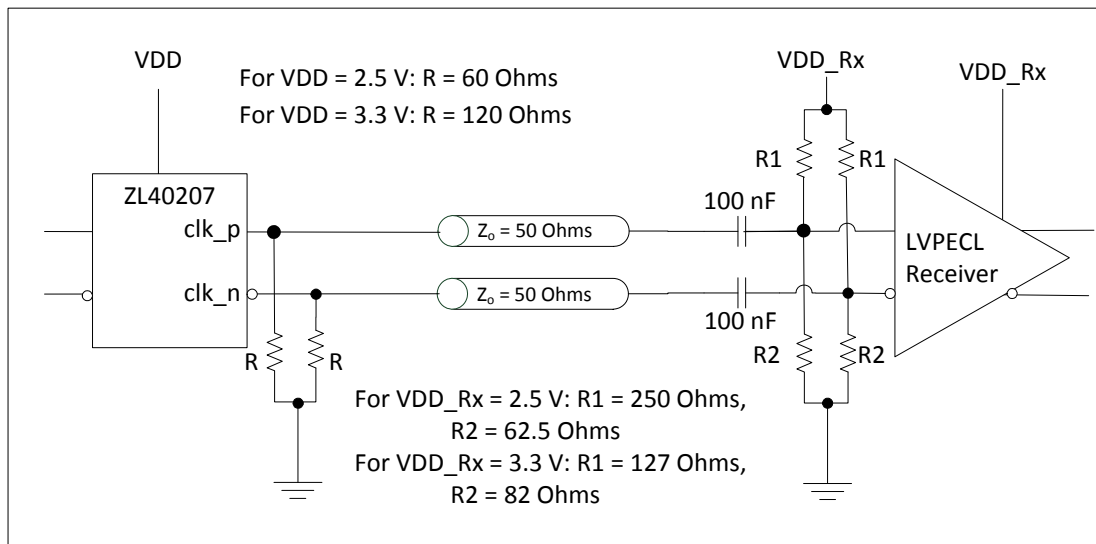


Figure 16 - LVPECL AC Output Termination

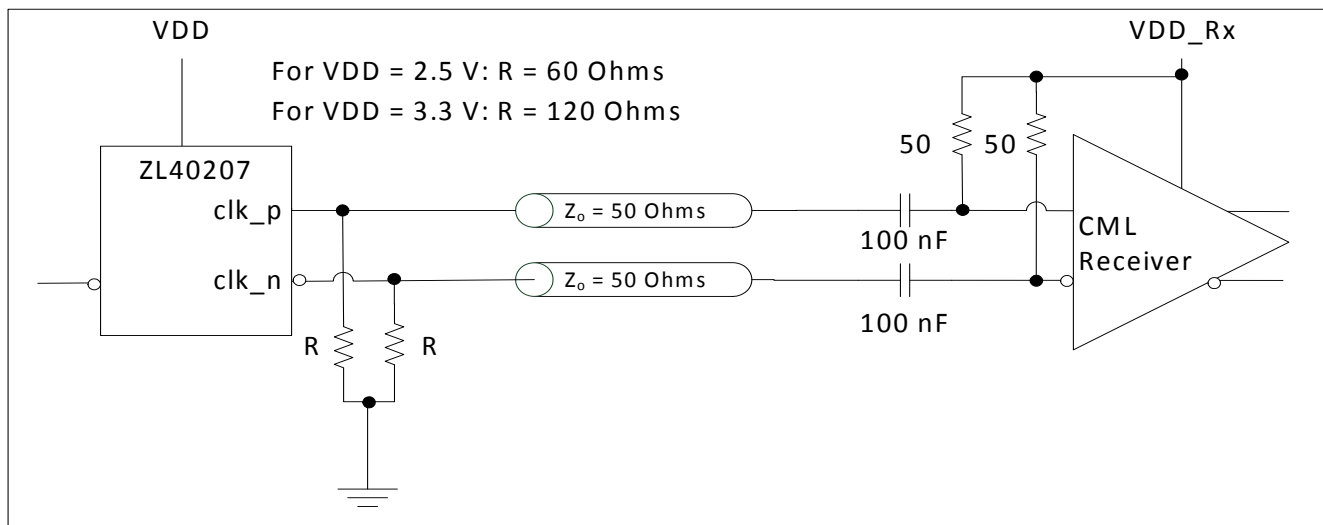


Figure 17 - LVPECL AC Output Termination for CML Inputs

### 3.3 Device Additive Jitter

The ZL40207 clock fanout buffer is not intended to filter clock jitter. The jitter performance of this type of device is characterized by its additive jitter. Additive jitter is the jitter the device would add to a hypothetical jitter-free clock as it passes through the device. The additive jitter of the ZL40207 is random and as such it is not correlated to the jitter of the input clock signal.

The square of the resultant random RMS jitter at the output of the ZL40207 is equal to the sum of the squares of the various random RMS jitter sources including: input clock jitter; additive jitter of the buffer; and additive random jitter due to power supply noise. There may be additional deterministic jitter sources, but they are not shown in Figure 18.

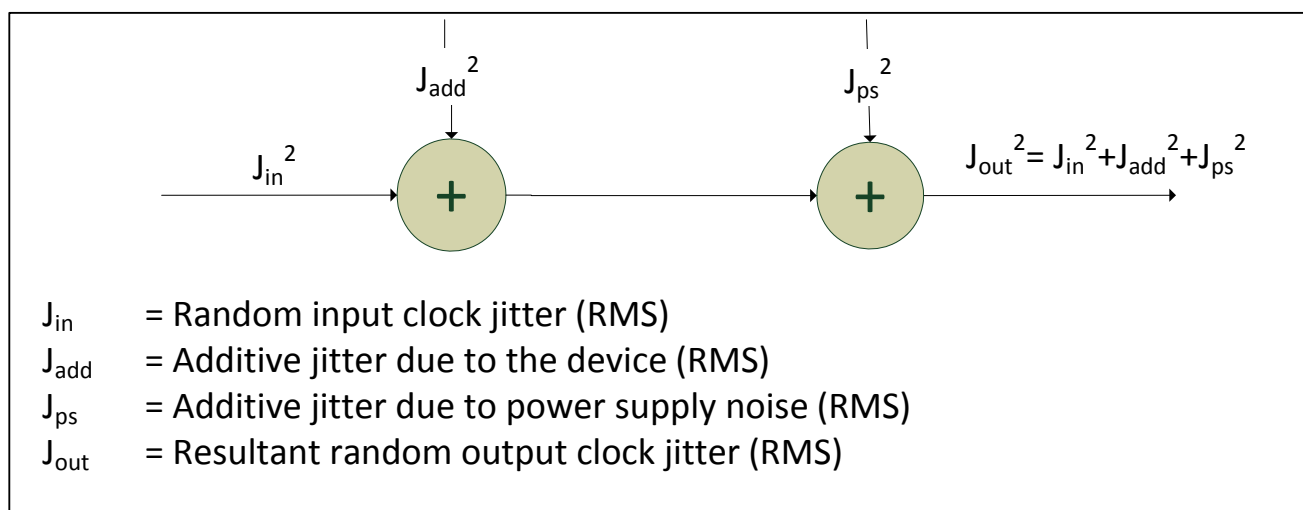


Figure 18 - Additive Jitter



### 3.4 Power Supply

This device operates employing either a 2.5V supply or 3.3V supply.

#### 3.4.1 Sensitivity to power supply noise

Power supply noise from sources such as switching power supplies and high-power digital components such as FPGAs can induce additive jitter on clock buffer outputs. The ZL40207 is equipped with a low drop out (LDO) regulator and on-chip bulk capacitors to minimize additive jitter due to power supply noise. The on-chip regulation, recommended power supply filtering, and good PCB layout all work together to minimize the additive jitter from power supply noise.

#### 3.4.2 Power supply filtering

Jitter levels may increase when noise is present on the power pins. For optimal jitter performance, the device should be isolated from the power planes connected to its power supply pins as shown in Figure 19.

- 10  $\mu\text{F}$  capacitors should be size 0603 or size 0805 X5R or X7R ceramic, 6.3 V minimum rating
- 0.1  $\mu\text{F}$  capacitors should be size 0402 X5R ceramic, 6.3 V minimum rating
- Capacitors should be placed next to the connected device power pins
- a 0.3 ohm resistor is recommended

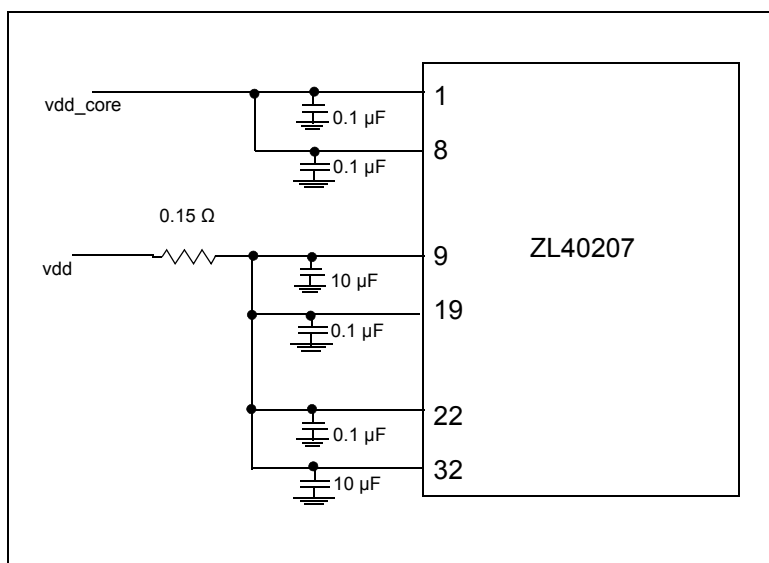


Figure 19 - Decoupling Connections for Power Pins

#### 3.4.3 PCB layout considerations

The power nets in Figure 19 can be implemented either as a plane island or routed power topology without changing the overall jitter performance of the device.

## 4.0 AC and DC Electrical Characteristics

### Absolute Maximum Ratings\*

	Parameter	Sym.	Min.	Max.	Units
1	Supply voltage	$V_{DD\_R}$	-0.5	4.6	V
2	Voltage on any digital pin	$V_{PIN}$	-0.5	$V_{DD}$	V
4	LVPECL output current	$I_{out}$		30	mA
5	Soldering temperature	T		260	°C
6	Storage temperature	$T_{ST}$	-55	125	°C
7	Junction temperature	$T_j$		125	°C
8	Voltage on input pin	$V_{input}$		$V_{DD}$	V
9	Input capacitance each pin	$C_p$		500	fF

\* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

\* Voltages are with respect to ground (GND) unless otherwise stated

### Recommended Operating Conditions\*

	Characteristics	Sym.	Min.	Typ.	Max.	Units
1	Supply voltage 2.5 V mode	$V_{DD25}$	2.375	2.5	2.625	V
2	Supply voltage 3.3 V mode	$V_{DD33}$	3.135	3.3	3.465	V
3	Operating temperature	$T_A$	-40	25	85	°C

\* Voltages are with respect to ground (GND) unless otherwise stated

### DC Electrical Characteristics - Current Consumption

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Notes
1	Supply current LVPECL drivers - unloaded	$I_{dd\_unload}$		122		mA	
2	Supply current LVPECL drivers - loaded (all outputs are active)	$I_{dd\_load}$		253		mA	Including power to $R_L = 50\Omega$

### DC Electrical Characteristics - Inputs and Outputs - for 3.3 V Supply

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Notes
1	CMOS control logic high-level input voltage	$V_{CIH}$	$0.7 \cdot V_{DD}$			V	
2	CMOS control logic low-level input voltage	$V_{CIL}$			$0.3 \cdot V_{DD}$	V	
3	CMOS control logic Input leakage current	$I_{IL}$		1		$\mu A$	$V_I = V_{DD}$ or 0 V
4	Differential input common mode voltage	$V_{CM}$	1.1		2.0	V	
5	Differential input voltage difference	$V_{ID}$	0.25		1	V	
6	Differential input resistance	$V_{IR}$	80	100	120	ohm	

**DC Electrical Characteristics - Inputs and Outputs - for 3.3 V Supply**

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Notes
7	LVPECL output high voltage	$V_{OH}$	$V_{DD} - 1.40$			V	
8	LVPECL output low voltage	$V_{OL}$			$V_{DD} - 1.62$	V	
9	LVPECL output differential voltage*	$V_{OD}$	0.5		0.9	V	

\* This parameter was measured from 125 MHz to 750 MHz.

**DC Electrical Characteristics - Inputs and Outputs - for 2.5 V Supply**

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Notes
1	Differential input common mode voltage	$V_{CM}$	1.1		1.6	V	
2	Differential input voltage difference	$V_{ID}$	0.25		1	V	
3	Differential input resistance	$V_{IR}$	80	100	120	ohm	
4	LVPECL output high voltage	$V_{OH}$	$V_{DD} - 1.40$			V	
5	LVPECL output low voltage	$V_{OL}$			$V_{DD} - 1.62$	V	
6	LVPECL output differential voltage*	$V_{OD}$	0.4		0.9	V	

\* This parameter was measured from 125 MHz to 750 MHz.



**Figure 20 - Differential and Single-Ended Output Voltages Parameter Definitions**

**AC Electrical Characteristics\* - Inputs and Outputs (see Figure 21) - for 2.5/3.3 V supply.**

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Notes
1	Maximum Operating Frequency	$1/t_p$			750	MHz	
2	Input to output clock propagation delay	$t_{pd}$	0	1	2	ns	
3	Output to output skew	$t_{out2out}$		50	100	ps	
4	Part to part output skew	$t_{part2part}$		80	300	ps	
5	Output clock Duty Cycle degradation	$t_{PWH}/t_{PWL}$	-2	0	2	Percent	
6	LVPECL Output clock slew rate	$r_{SL}$	0.75	1.2		V/ns	

\* Supply voltage and operating temperature are as per Recommended Operating Conditions

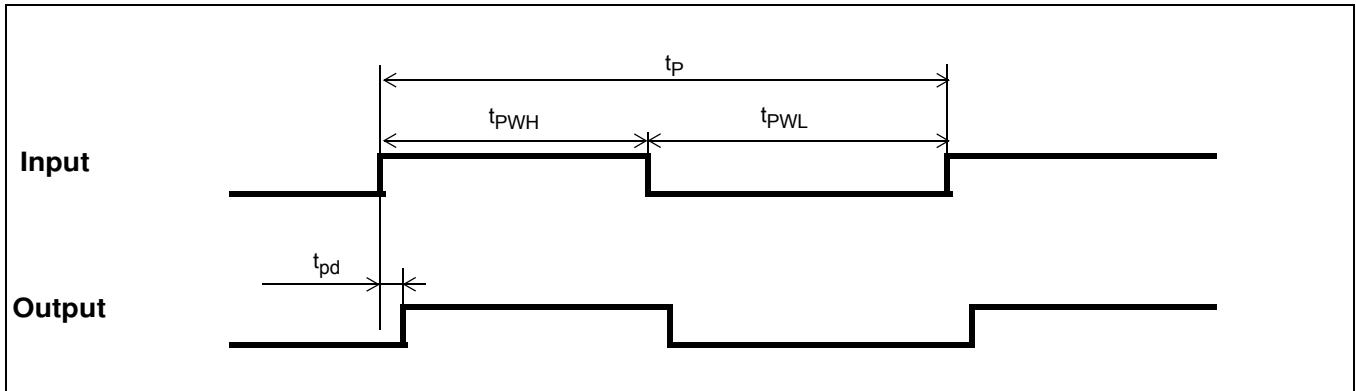


Figure 21 - Input To Output Timing

## 5.0 Performance Characterization

### Additive Jitter at 2.5 V\*

	Output Frequency (MHz)	Jitter Measurement Filter	Typical RMS (fs)	Notes
1	125	12 kHz - 20 MHz	139	
2	212.5	12 kHz - 20 MHz	109	
3	311.04	12 kHz - 20 MHz	85	
4	425	12 kHz - 20 MHz	57	
5	500	12 kHz - 20 MHz	50	
6	622.08	12 kHz - 20 MHz	40	
7	750	12 kHz - 20 MHz	36	

\*The values in this table were taken with an approximate slew rate of 0.8 V/ns.

### Additive Jitter at 3.3 V\*

	Output Frequency (MHz)	Jitter Measurement Filter	Typical RMS (fs)	Notes
1	125	12 kHz - 20 MHz	115	
2	212.5	12 kHz - 20 MHz	85	
3	311.04	12 kHz - 20 MHz	72	
4	425	12 kHz - 20 MHz	55	
5	500	12 kHz - 20 MHz	48	
6	622.08	12 kHz - 20 MHz	41	
7	750	12 kHz - 20 MHz	39	

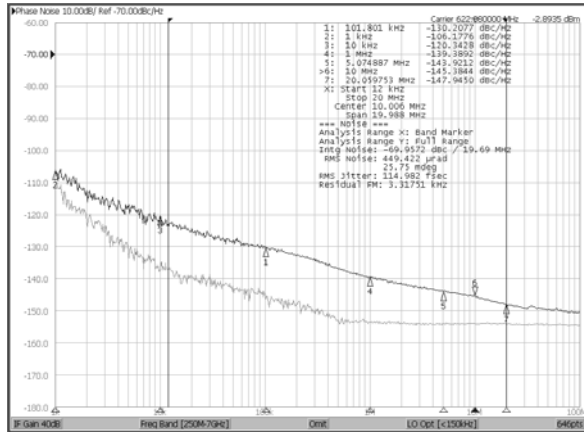
\*The values in this table were taken with an approximate slew rate of 0.8 V/ns.

### Additive Jitter from a Power Supply Tone\*

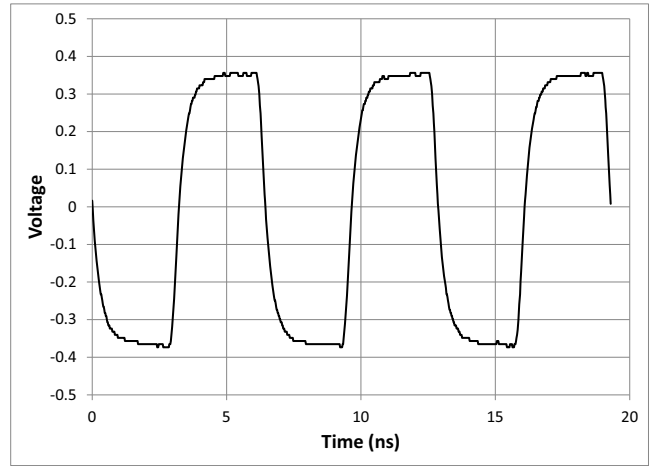
Carrier frequency	Parameter	Typical	Units	Notes
125MHz	25 mV at 100 kHz	115	fs RMS	
750MHz	25 mV at 100 kHz	59	fs RMS	

\* The values in this table are the additive periodic jitter caused by an interfering tone typically caused by a switching power supply. For this test, measurements were taken over the full temperature and voltage range for  $V_{DD} = 2.5$  V. The magnitude of the interfering tone is measured at the DUT.

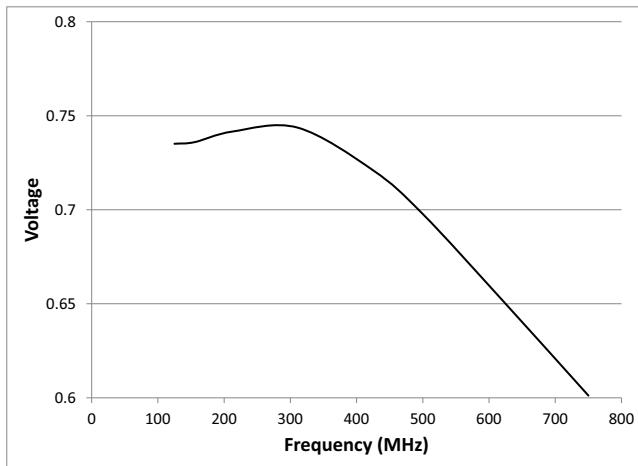
## 6.0 Typical Behavior



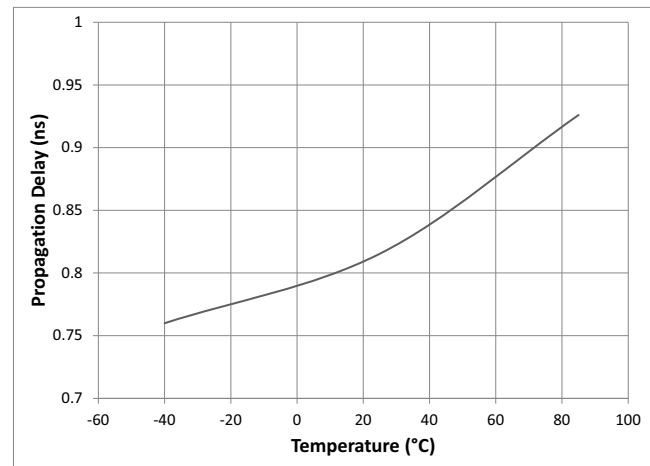
Typical Phase Noise at 622.08 MHz



Typical Waveform at 155.52 MHz

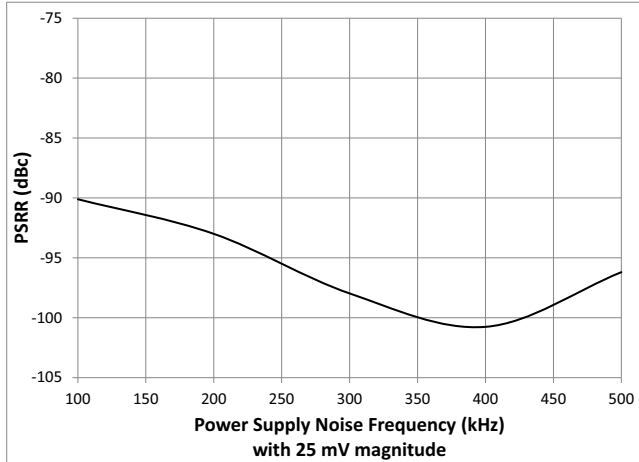


$V_{OD}$  versus Frequency

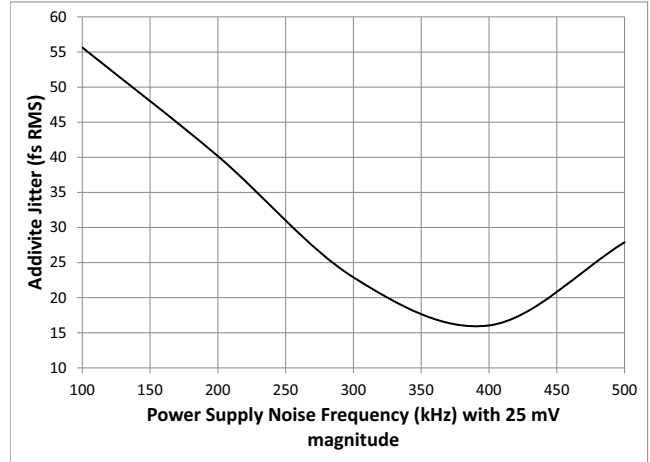


Propagation Delay versus Temperature

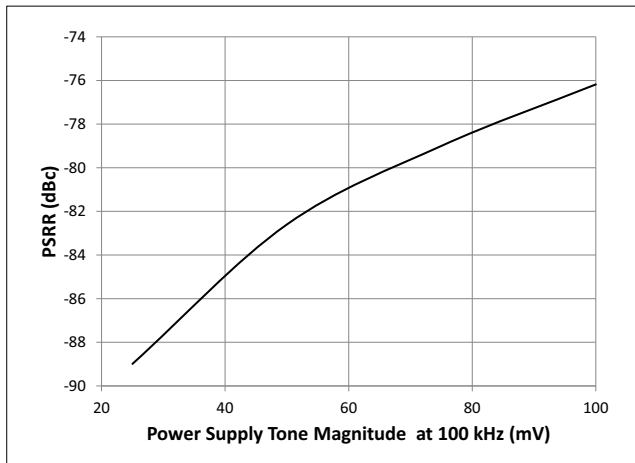
Note: This is for a single device. For more details see the



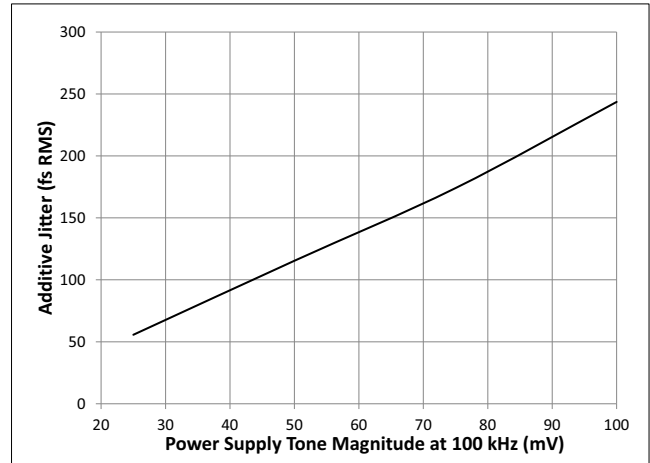
Power Supply Tone Frequency (at 25 mV) versus PSRR at 125 MHz



Power Supply Tone Frequency (at 25 mV) versus Additive Jitter at 125 MHz



Power Supply Tone Magnitude (at 100 kHz) versus PSRR at 125 MHz



Power Supply Tone Magnitude (at 100 kHz) versus Additive Jitter at 125 MHz

## 7.0 Package Characteristics

### Thermal Data

Parameter	Symbol	Test Condition	Value	Unit
Junction to Ambient Thermal Resistance	$\Theta_{JA}$	Still Air	37.4	$^{\circ}\text{C}/\text{W}$
		1 m/s	33.1	
		2 m/s	31.5	
Junction to Case Thermal Resistance	$\Theta_{JC}$		24.4	$^{\circ}\text{C}/\text{W}$
Junction to Board Thermal Resistance	$\Theta_{JB}$		19.5	$^{\circ}\text{C}/\text{W}$
Maximum Junction Temperature*	$T_{jmax}$		125	$^{\circ}\text{C}$
Maximum Ambient Temperature	$T_A$		85	$^{\circ}\text{C}$







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